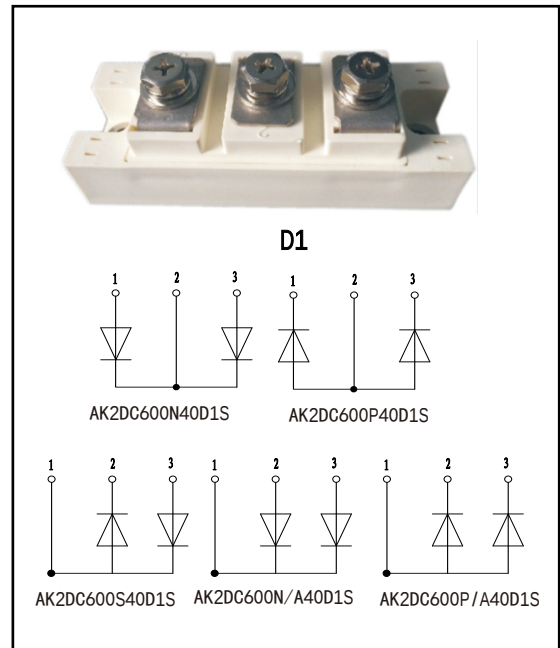


PRODUCT FEATURES

- ☑ Ultrafast Reverse Recovery Time
- ☑ Soft Reverse Recovery Characteristics
- ☑ Low Reverse Recovery Loss
- ☑ Low Forward Voltage
- ☑ High Surge Current Capability
- ☑ Low Inductance Package

APPLICATIONS

- ☑ Inversion Welder
- ☑ Uninterruptible Power Supply (UPS)
- ☑ Plating Power Supply
- ☑ Ultrasonic Cleaner and Welder
- ☑ Converter & Chopper
- ☑ Power Factor Correction (PFC) Circuit



ABSOLUTE MAXIMUM RATINGS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Values	Unit
V_R	Maximum D.C. Reverse Voltage		400	V
V_{RRM}	Maximum Repetitive Reverse Voltage		400	V
$I_{F(AV)}$	Average Forward Current	$T_C=110^{\circ}\text{C}$, Per Diode	600	A
		$T_C=120^{\circ}\text{C}$, 20KHz, Per Moudle	400	A
$I_{F(RMS)}$	RMS Forward Current	$T_C=110^{\circ}\text{C}$, Per Diode	840	A
I_{FSM}	Non-Repetitive Surge Forward Current	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, 50Hz, Sine	4800	A
		$T_J=45^{\circ}\text{C}$, $t=8.3\text{ms}$, 60Hz, Sine	5100	A
I^2t	I^2t (For Fusing)	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, 50Hz, Sine	115200	A^2s
		$T_J=45^{\circ}\text{C}$, $t=8.3\text{ms}$, 60Hz, Sine	130050	A^2s
P_D	Power Dissipation		1665	W
T_J	Junction Temperature		-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^{\circ}\text{C}$
V_{isol}	Insulation Test Voltage	AC, $t=1\text{min}$	3000	V
Torque	Module-to-Sink	Recommended (M6)	3~5	N.M
Torque	Module Electrodes	Recommended (M6)	3~5	N.M
$R_{\theta JC}$	Thermal Resistance	Junction-to-Case	0.075	$^{\circ}\text{C} / \text{W}$
Weight			155	g

ELECTRICAL CHARACTERISTICS
 $T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Reverse Leakage Current	$V_R=400\text{V}$	--	--	2	mA
		$V_R=400\text{V}, T_J=125^{\circ}\text{C}$	--	--	10	mA
V_F	Forward Voltage	$I_F=600\text{A}$	--	1.15	1.65	V
		$I_F=600\text{A}, T_J=125^{\circ}\text{C}$	--	--	1.45	V
t_{rr}	Reverse Recovery Time	$I_F=1\text{A}, V_R=30\text{V}, di_F/dt=-200\text{A}/\mu\text{s}$	--	65	--	ns
t_{rr}	Reverse Recovery Time	$V_R=200\text{V}, I_F=600\text{A}$ $di_F/dt=-200\text{A}/\mu\text{s}, T_J=25^{\circ}\text{C}$	--	175	--	ns
I_{RRM}	Max. Reverse Recovery Current		--	26	--	A
t_{rr}	Reverse Recovery Time	$V_R=200\text{V}, I_F=600\text{A}$ $di_F/dt=-200\text{A}/\mu\text{s}, T_J=125^{\circ}\text{C}$	--	285	--	ns
I_{RRM}	Max. Reverse Recovery Current		--	45	--	A

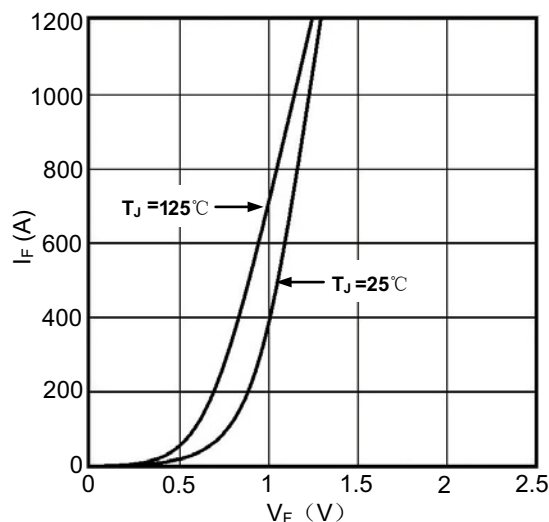
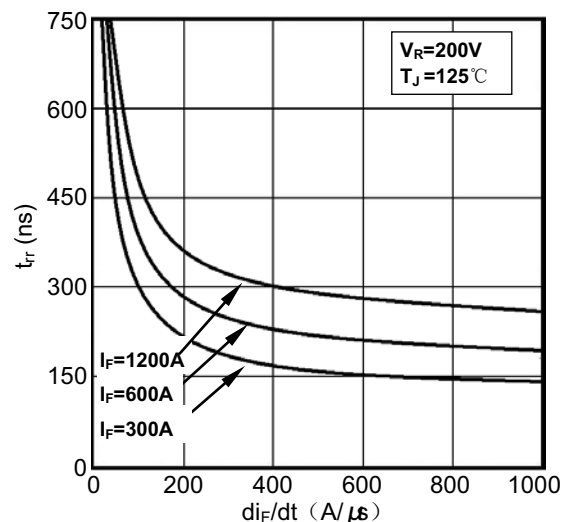
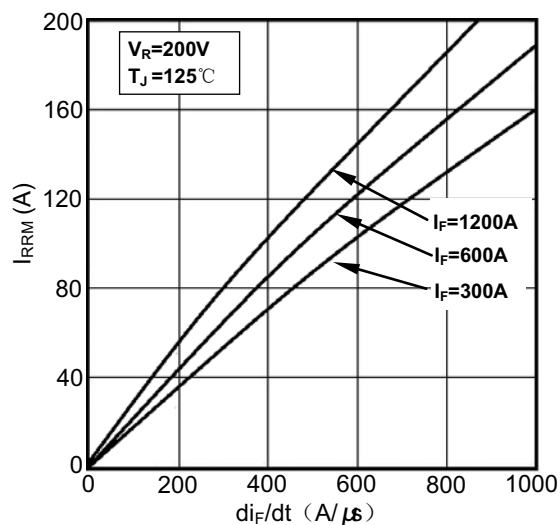
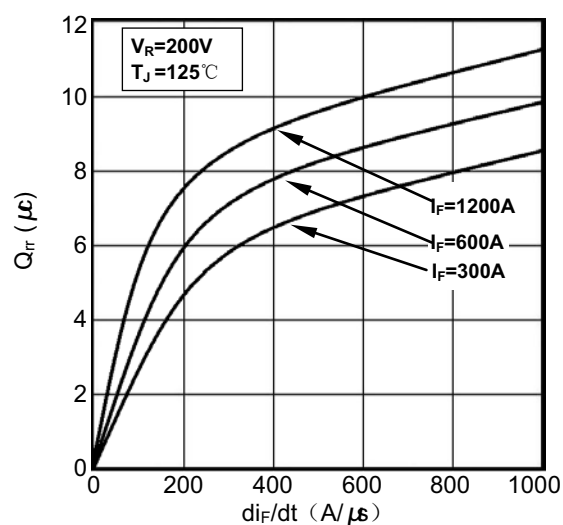


Figure1. Forward Voltage Drop vs Forward Current


 Figure2. Reverse Recovery Time vs di_F/dt

 Figure3. Reverse Recovery Current vs di_F/dt

 Figure4. Reverse Recovery Charge vs di_F/dt

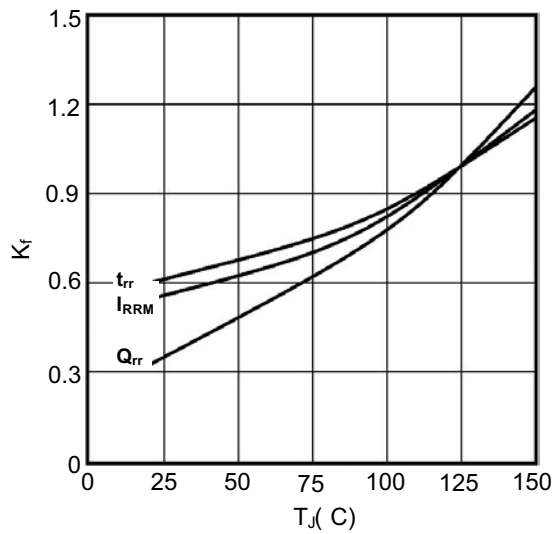


Figure5. Dynamic Parameters vs Junction Temperature

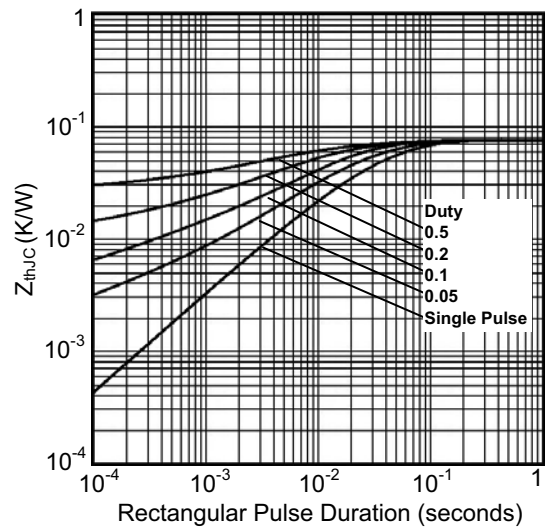
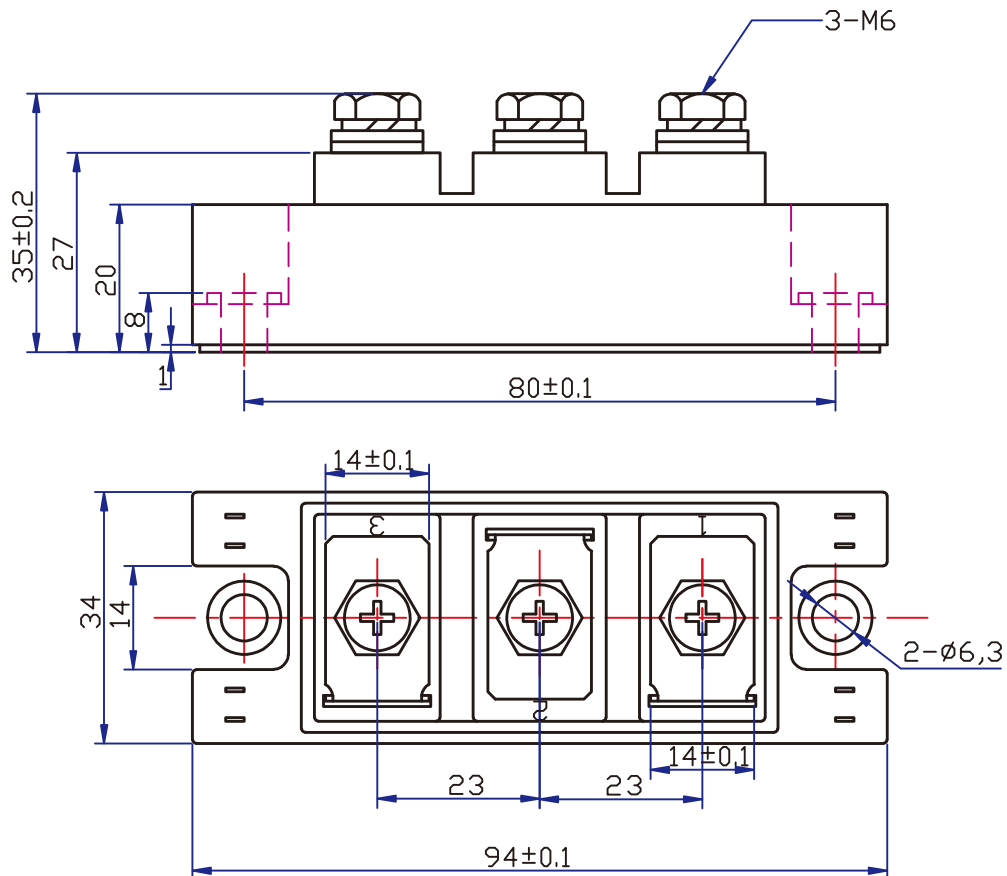


Figure6. Transient Thermal Impedance

Package Outlines



Unit:mm